

CHANGES TO THE SPECIFICATION FOR SEALING CHIP

The major changes in the 2019 edition of the Sealing Chip Specification are as follows:

- More prescriptive sample preparation requirements for testing of aggregate source properties.
- Inclusion of Glenbrook Melter Aggregate (GMA) in the body of the specification.
- Alignment of skid resistance requirements with the T10 specification.
- Allowance of a New Zealand sourced control stone for the Polished Stone Value test, in place of UK sourced aggregate.
- A requirement to measure and report the Cleanness Value for Grades 5 and 6 chip.
- A requirement to measure and report the Size, Shape and Broken Faces for Grade 5 chip.

Several minor and editorial changes have also been made to the 2019 edition of the Sealing Chip specification, including:

- The addition of a related documents section.
- Reference to and a requirement to comply with the *Quality Assurance of Aggregates for Roads* by Civil Contractors New Zealand.

CHANGES TO THE NOTES TO M06 SPECIFICATION FOR SEALING CHIP

The major changes in this 2019 edition of the Notes to the Sealing Chip specification are:

- A rewrite of the Skid Resistance section to align it with T10 and to improve clarity.
- A new section discussing the Aggregate Performance method for selecting a surfacing aggregate.
- A rewrite of the Polished Stone Value section to reflect current knowledge.
- Photographs of correctly prepared PSV test specimens to assist testing agencies with the preparation of representative test specimens.
- New sections on Production Properties and the Use of Recycled Asphalt Product.

Several minor and editorial improvements have also made to the 2019 edition of the Notes to the Sealing Chip specification.